TMOS Switching

N-Channel — Enhancement



MPF930 MPF960 MPF990



Max

1.7

2.4

3.0

3.5

4.8

Тур

1.2

1.2

2.2

2.8

2.8

Unit

MAXIMUM RATINGS

Rating	Symbol	MPF930	MPF960	MPF99	0 Unit
Drain-Source Voltage	VDS	35	60	90	Vdc
Drain-Gate Voltage	VDG	35	60	90	Vdc
$\begin{array}{l} \mbox{Gate-Source Voltage} \\ \mbox{Continuous} \\ \mbox{Non-repetitive } (t_p \leq 50 \ \mu s) \end{array}$	VGS VGSM		±20 ±40		Vdc Vpk
Drain Current Continuous(1) Pulsed ⁽²⁾	D ^I D DM		2.0 3.0		Adc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD		1.0 8.0		Watts mW/ºC
Operating and Storage Junction Temperature Range	⊤ _J , T _{stg}	-55 to 150			°C
Thermal Resistance	θJA	125			°C/W
ELECTRICAL CHARACTERIS	STICS (T _A =	25°C unles	s otherwise	noted)	
Characteristic				Symbol	
OFF CHARACTERISTICS				ı	
Drain-Source Breakdown Voltage)				V(BR)DSX

Drain–Source Breakdown Voltage (V _{GS} = 0, I _D = 10 μAdc)	MPF930 MPF960 MPF990	V(BR)DSX	35 60 90			Vdc
Gate Reverse Current (V _{GS} = 15 Vdc, V _D	s = 0)	IGSS	_	-	50	nAdc
ON CHARACTERISTICS(2)		terratiken de		•	#n.e.	
Zero–Gate–Voltage Drain Current (V _{DS} = Maximum Rating, V _{GS} = 0)	• • 9450	IDSS	_	T -	10	μAdc
Gate Threshold Voltage (I _D = 1.0 mAdc, V _{DS} = V _{GS})	· 41 11	V _{GS(Th)}	1.0	-	3.5	Vdc
Drain–Source On–Voltage (V _{GS} = 10 Vdc) (I _D = 0.5 Adc)	MPF930 MPF960 MPF990	VDS(on)	 	0.4 0.6 0.6	0.7 0.8 1.2	Vdc
(I _D = 1.0 Adc)	MPF930			0. 9	1.4	

MPF960

MPF990

MPF930

MPF960

MPF990

1. The Power Dissipation of the package may result in a lower continuous drain current.

2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

. _ _ _ _ _ _



Quality Semi-Conductors

 $(I_D = 2.0 \text{ Adc})$

MPF930 MPF960 MPF990

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic		Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS ⁽²⁾ (Continued)				• • • •		
Static Drain–Source On Resistance (V _{GS} = 10 Vdc, I _D = 1.0 Adc)	MPF930 MPF960 MPF990	۲DS(on)		0.9 1.2 1.2	1.4 1.7 2.0	Ω
On–State Drain Current (V _{DS} = 25 Vdc, V _{GS} = 10 Vdc)		^I D(on)	1.0	2.0	_	Amps
SMALL-SIGNAL CHARACTERISTICS			I	I	.	
Input Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz)		C _{iss}		70		pF
Reverse Transfer Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz)		C _{rss}		20		ρF
Output Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz)	· · · ·	C _{oss}		49		pF
Forward Transconductance (V _{DS} = 25 Vdc, I _D = 0.5 Adc)		9fs	200	380	_	mmhos
SWITCHING CHARACTERISTICS		•				
Turn–On Time	1.2.10.40 Apr	ton	_	7.0	15	ns
Turn–Off Time		toff	_	7.0	15	ns

2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

RESISTIVE SWITCHING



Figure 1. Switching Test Circuit

Figure 2. Switching Waveforms